

### **N-Channel Enhancement Mode MOSFET**

#### Features

- Surface-mounted package
- Extremely low threshold voltage
- Advanced trench cell design
- ESD protected (HBM > 2KV)

#### Applications

• Portable appliances

#### **Quick reference**

- BV  $\geq 60$  V Ptot  $\leq 0.83$  W ID  $\leq 0.43$  A
- RDS(ON)  $\leq$  3  $\Omega$  (*a*) VGS = 10 V
- RDS(ON)  $\leq 4 \Omega$  @ VGS = 4.5 V

### **Pin Description**

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Pin Description	Simplified Outline	Symbol
1 Gate(G) 2 Source(S) 3 Drain(D)		

### **Limiting Values**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	Drain-Source Voltage	T <sub>A</sub> = 25 °C	-	60	V
V <sub>GS</sub>	Gate-Source Voltage	T <sub>A</sub> = 25 °C	-	± 20	V
I <sub>D</sub> *	Drain Current	T <sub>A</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	0.43	А
I <sub>DM</sub> ***	Pulsed Drain Current	T <sub>A</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	1.7	А
P <sub>tot</sub> *	Total Power Dissipation	T <sub>A</sub> = 25 °C	-	0.83	w
r <sub>tot</sub>		T <sub>A</sub> = 100 °C	-	0.33	vv
T <sub>stg</sub>	Storage Temperature		- 55	150	°C
TJ	Junction Temperature		-	150	°C
۱ <sub>S</sub> *	Diode Forward Current	T <sub>A</sub> = 25 °C	-	0.4	А
R <sub>eja</sub> *	Thermal Resistance- Junction to	Ambient	-	150	°C / W

Notes : \* Surface Mounted on 1 in 2 pad area,  $t \le 10$  sec \*\* Pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

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## 2N7002

### Electrical Characteristics (TA = 25 $^{\circ}$ C Unless Otherwise Noted )

Symbol	Parameter	Conditio	ons	Min	Тур	Max	Unit	
Static Cha	aracteristics	1			1	1		
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{DS} = 2$	50 µA	60	-	-	V	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{DS}} = 2$	50 µA	1.0	1.6	2.5	V	
	Drain Leakage Current	$V_{DS}$ = 48 V, $V_{GS}$ =	0 V	-	-	1	μA	
DSS	Drain Leakage Current		T <sub>J</sub> = 85 °C	-	-	30	μA	
I <sub>GSS</sub>	Gate Leakage Current	$V_{GS}$ = ± 20 V, $V_{DS}$	= 0 V	-	-	± 10	μA	
	On-State Resistance	$V_{GS}$ = 10 V, $I_{DS}$ = 0	).4 A		1.9	3.0	$- \Omega$	
R <sub>DS(ON)</sub> <sup>a</sup>	On-State Resistance	V <sub>GS</sub> = 4.5 V, I <sub>DS</sub> =	0.3 A	-	2.4	4.0		
Diode Cha	aracteristics	·						
V <sub>SD</sub> <sup>a</sup>	Diode Forward Voltage	$I_{SD} = 0.4 \text{ A}, V_{GS} = 0.4 \text{ A}$	0 V	-	0.7	1.3	V	
t <sub>rr</sub>	Reverse Recovery Time		# - 100 A (up	-	40	-	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{SD} = 0.4 \text{ A}, \text{ dI}_{SD} / \text{ c}$	μ = 100 A / μs	-	40	-	nC	
Dynamic	Characteristics <sup>b</sup>							
R <sub>G</sub>	Gate Resistance	$V_{GS} = V_{DS} = 0 V, F$	<sup>-</sup> = 1 MHz	-	130	-	Ω	
C <sub>iss</sub>	Input Capacitance			-	30	-		
C <sub>oss</sub>	Output Capacitance	│ V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 2 │ Frequency = 1 MF		-	4.2	-	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	-	3	-		
t <sub>d</sub> (on)	Turn-on Delay Time	V <sub>DS</sub> = 30 V, V <sub>GEN</sub> =	- 10 V	-	3.9	9		
t <sub>r</sub>	Turn-on Rise Time	$R_{G} = 25 \Omega, R_{L} = 13$		-	3.5	8		
t <sub>d</sub> (off)	Turn-off Delay Time	I <sub>DS</sub> = 0.2 A		-	16	40	ns	
t <sub>f</sub>	Turn-off Fall Time	1		-	10	20		
		·						
Qg	Total Gate Charge			-	305	-		
Q <sub>gs</sub>	Gate-Source Charge	│ V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = │ I <sub>DS</sub> = 0.4 A	= 10 V,	-	85	-	pC	
Q <sub>gd</sub>	Gate-Drain Charge			-	205	-	1	

Notes : a : Pulse test ; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

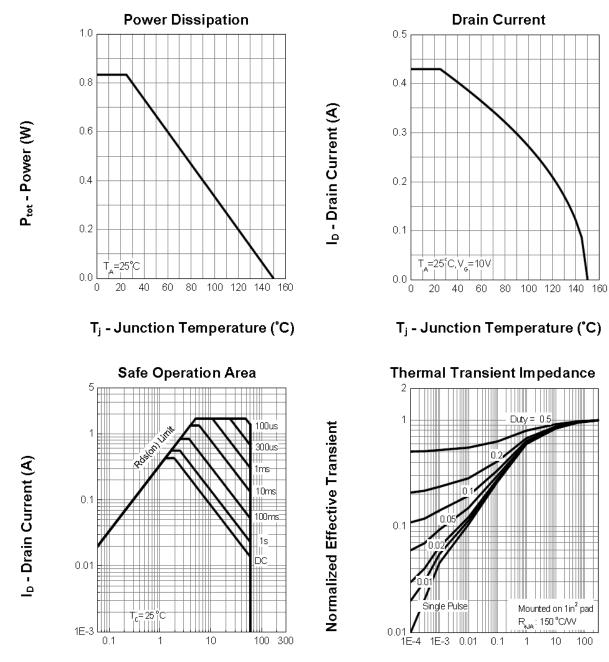
b : Guaranteed by design, not subject to production testing

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### **Typical Characteristics**

Square Wave Pulse Duration (sec)

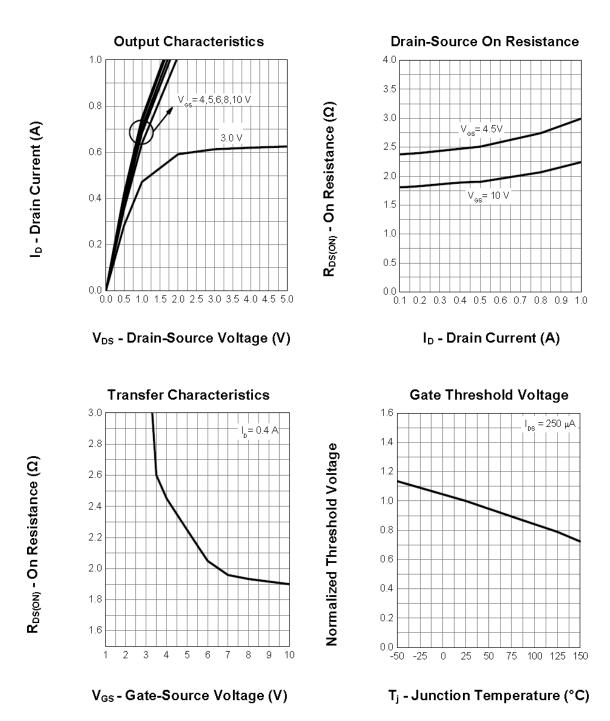
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V<sub>DS</sub> - Drain-Source Voltage (V)







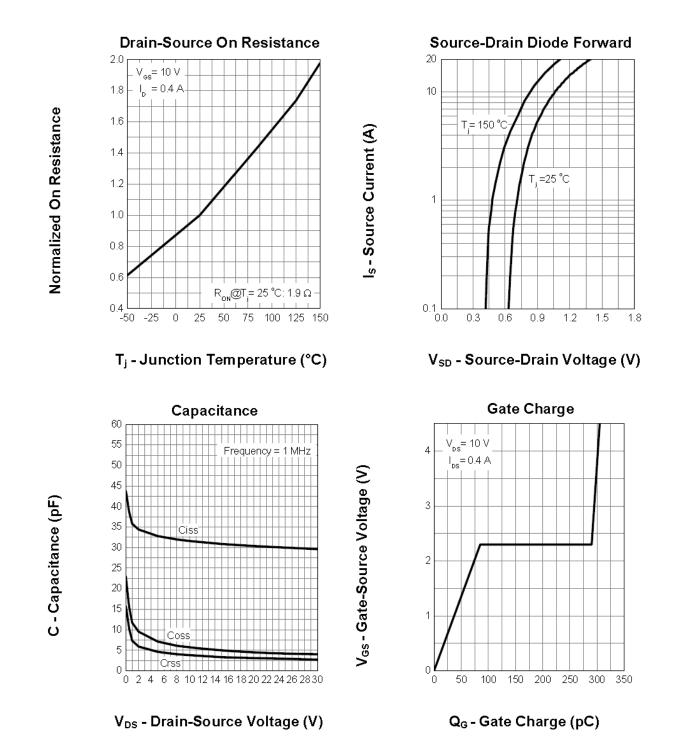


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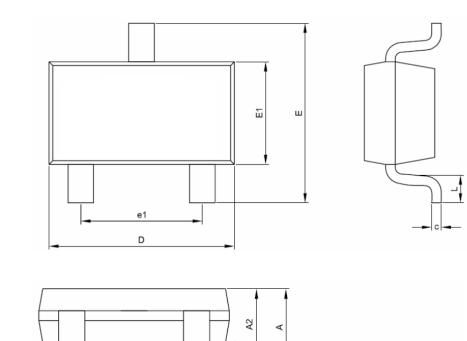








Package Dimensions SOT-23



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<u> </u>	Dimensions In Millimeters		
Symbol	MIN.	MAX.	
A	—	1.12	
A1	0.00	0.1	
A2	0.90	1.02	
D	2.90 BSC		
E	2.40 BSC		
E1	1.20	1.40	
с	0.08	0.25	
b	0.30	0.50	
e	0.95 BSC		
e1	1.90 BSC		
L	0.20	0.60	

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